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[Vishay/Siliconix](#)
[SI4834BDY-T1-E3](#)

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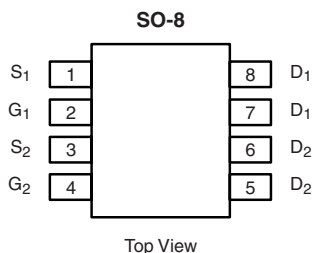


Si4834BDY
 Vishay Siliconix

Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
30	0.022 at V _{GS} = 10 V	7.5
	0.030 at V _{GS} = 4.5 V	6.5

SCHOTTKY PRODUCT SUMMARY		
V _{DS} (V)	V _{SD} (V) Diode Forward Voltage	I _F (A)
30	0.50 V at 1.0 A	2.0



FEATURES

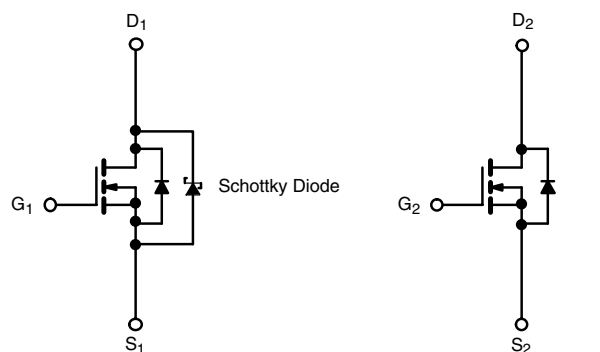
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



RoHS
 COMPLIANT
 HALOGEN
FREE
 Available

APPLICATIONS

- Symmetrical Buck-Boost DC/DC Converter



Ordering Information: Si4834BDY-T1-E3 (Lead (Pb)-free)
 Si4834BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted				
Parameter	Symbol	10 s	Steady State	Unit
Drain-Source Voltage	V _{DS}	30		V
Gate-Source Voltage	V _{GS}	± 20		
Continuous Drain Current (T _J = 150 °C) ^a	I _D	T _A = 25 °C	7.5	5.7
		T _A = 70 °C	6.0	4.6
Pulsed Drain Current	I _{DM}	30		A
Continuous Source Current (Diode Conduction) ^a	I _S	1.7	0.9	
Maximum Power Dissipation ^a	P _D	T _A = 25 °C	2.0	1.1
		T _A = 70 °C	1.3	0.7
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	MOSFET		Schottky		Unit
		Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient ^a	R _{thJA}	t ≤ 10 s	52	62.5	53	62.5
		Steady State	93	110	93	110
Maximum Junction-to-Foot (Drain)	R _{thJF}	Steady State	35	40	35	40

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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MOSFET SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	0.8		3.0	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}, V_{GS} = \pm 20\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30\ \text{V}, V_{GS} = 0\ \text{V}$	Ch-1		100	μA
			Ch-2		1	
		$V_{DS} = 30\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 85\text{ }^\circ\text{C}$	Ch-1		2000	
			Ch-2		15	
On-State Drain Current ^b	$I_{D(on)}$	$V_{DS} = 5\ \text{V}, V_{GS} = 10\ \text{V}$	20			A
Drain-Source On-State Resistance ^b	$R_{DS(on)}$	$V_{GS} = 10\ \text{V}, I_D = 7.5\ \text{A}$		0.017	0.022	Ω
		$V_{GS} = 4.5\ \text{V}, I_D = 6.5\ \text{A}$		0.024	0.030	
Forward Transconductance ^b	g_{fs}	$V_{DS} = 15\ \text{V}, I_D = 7.5\ \text{A}$		19		S
Diode Forward Voltage ^b	V_{SD}	$I_S = 1\ \text{A}, V_{GS} = 0\ \text{V}$	Ch-1	0.47	0.5	V
			Ch-2	0.75	1.2	
Dynamic^a						
Total Gate Charge	Q_g	$V_{DS} = 15\ \text{V}, V_{GS} = 4.5\ \text{V}, I_D = 7.5\ \text{A}$		7	11	nC
Gate-Source Charge	Q_{gs}			2.9		
Gate-Drain Charge	Q_{gd}			2.5		
Gate Resistance	R_g		0.5	1.5	2.6	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15\ \text{V}, R_L = 15\ \Omega$ $I_D \cong 1\ \text{A}, V_{GEN} = 10\ \text{V}, R_g = 6\ \Omega$		9	15	ns
Rise Time	t_r			10	17	
Turn-Off Delay Time	$t_{d(off)}$			19	30	
Fall Time	t_f			9	15	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 1.7\ \text{A}, di/dt = 100\ \text{A}/\mu\text{s}$	Ch-1	32	55	
			Ch-2	35	55	

Notes:

- a. Guaranteed by design, not subject to production testing.
 b. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

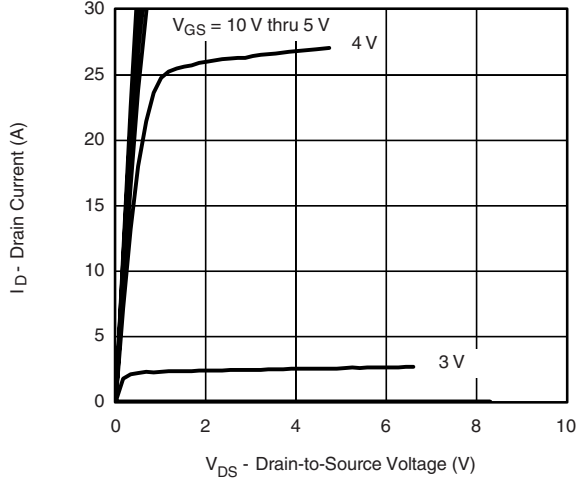
SCHOTTKY SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	V_F	$I_F = 1.0\ \text{A}$		0.47	0.50	V
		$I_F = 1.0\ \text{A}, T_J = 125\text{ }^\circ\text{C}$		0.36	0.42	
Maximum Reverse Leakage Current	I_{rm}	$V_R = 30\ \text{V}$		0.004	0.100	mA
		$V_R = 30\ \text{V}, T_J = 100\text{ }^\circ\text{C}$		0.7	10	
		$V_R = -30\ \text{V}, T_J = 125\text{ }^\circ\text{C}$		3.0	20	
Junction Capacitance	C_T	$V_R = 10\ \text{V}$		50		pF

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

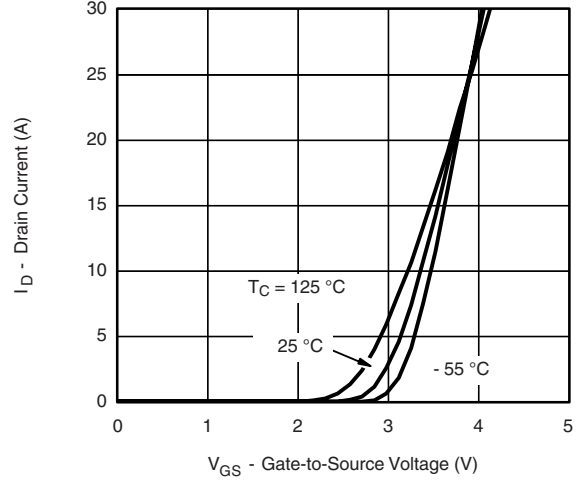


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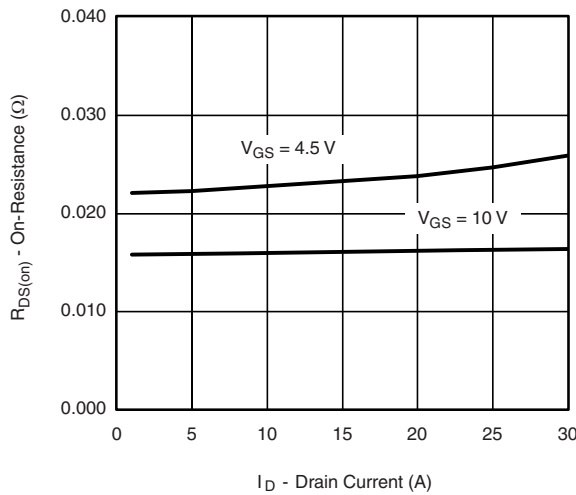
MOSFET TYPICAL CHARACTERISTICS 25 °C unless otherwise noted



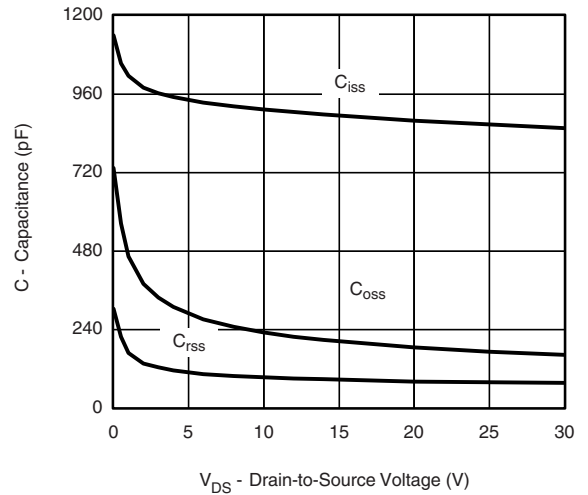
Output Characteristics



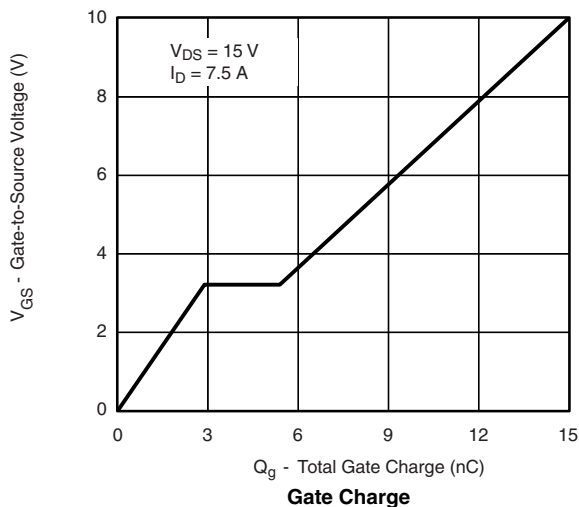
Transfer Characteristics



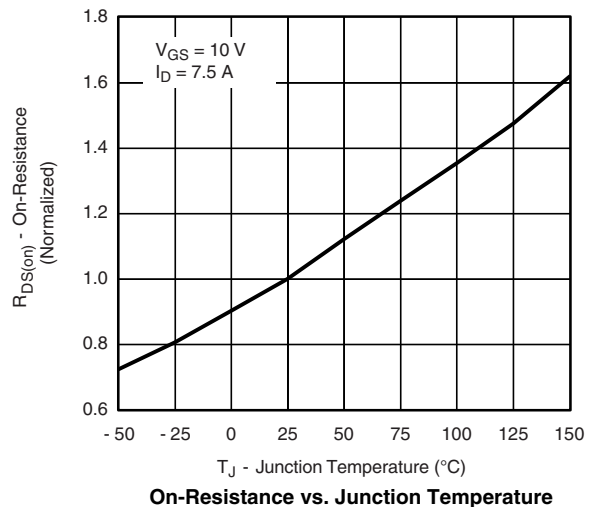
On-Resistance vs. Drain Current



Capacitance



Gate Charge

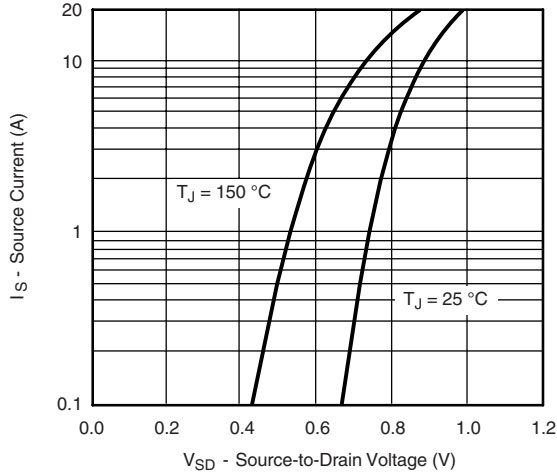


On-Resistance vs. Junction Temperature

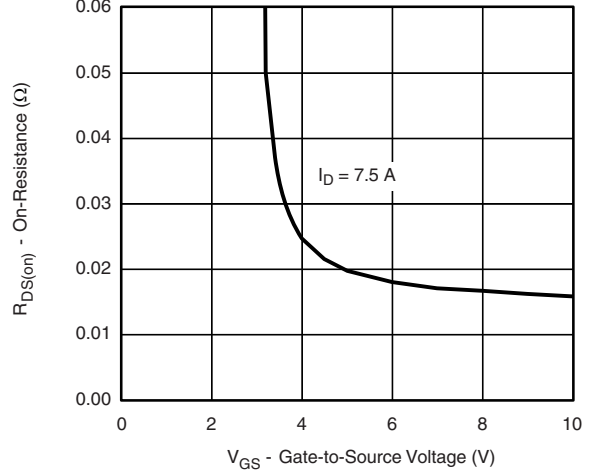
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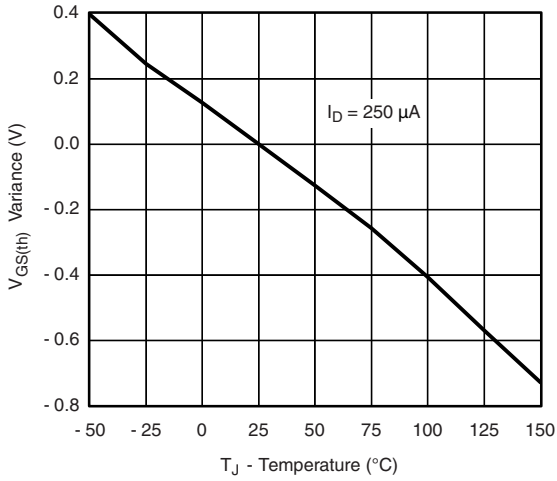
MOSFET TYPICAL CHARACTERISTICS 25 °C unless otherwise noted



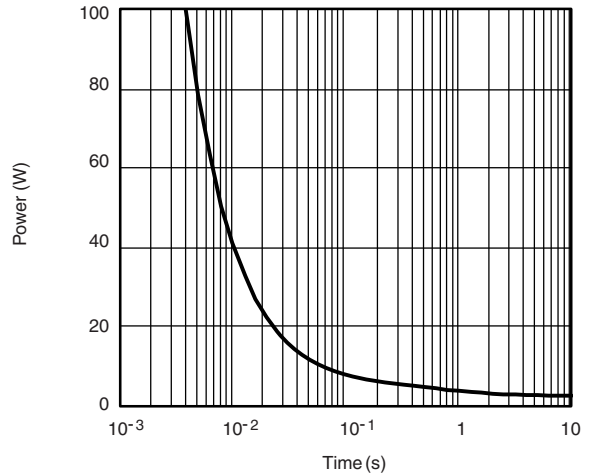
Source-Drain Diode Forward Voltage



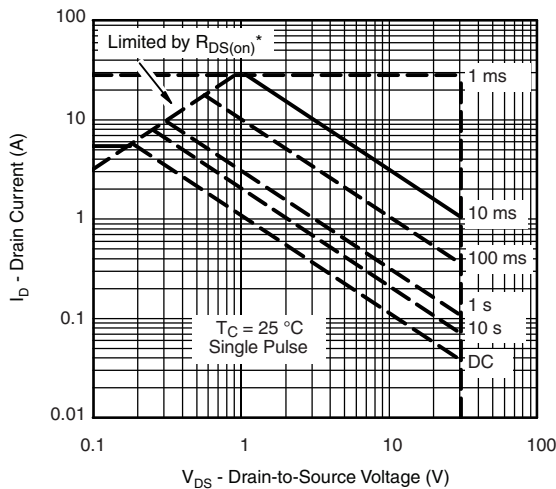
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



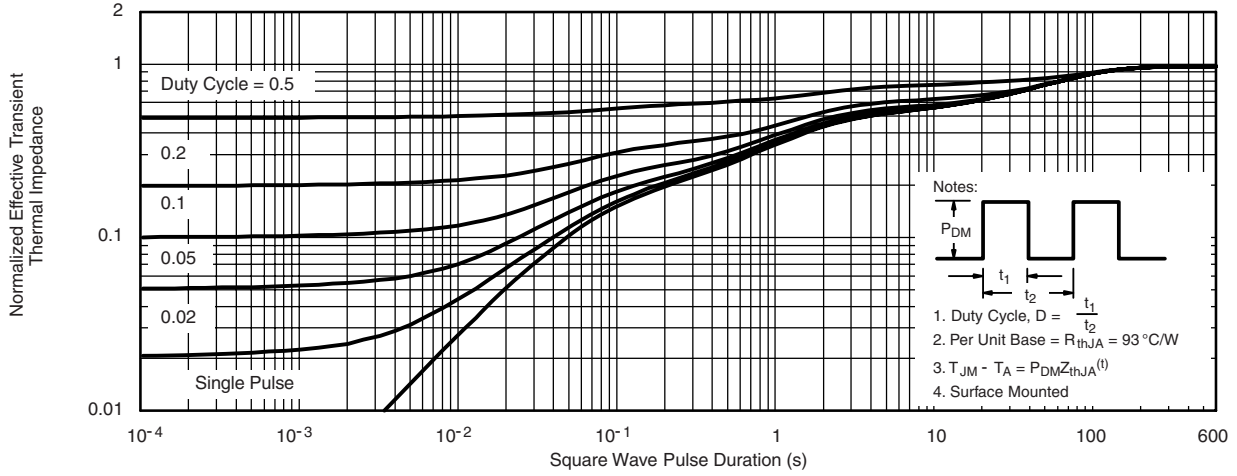
* $V_{DS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Foot

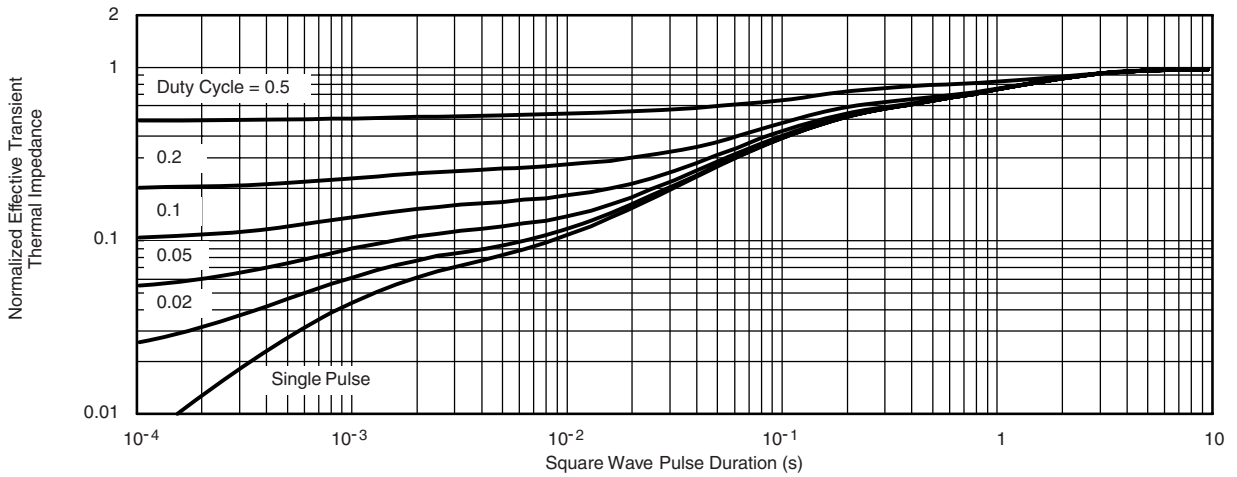


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MOSFET TYPICAL CHARACTERISTICS 25 °C unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

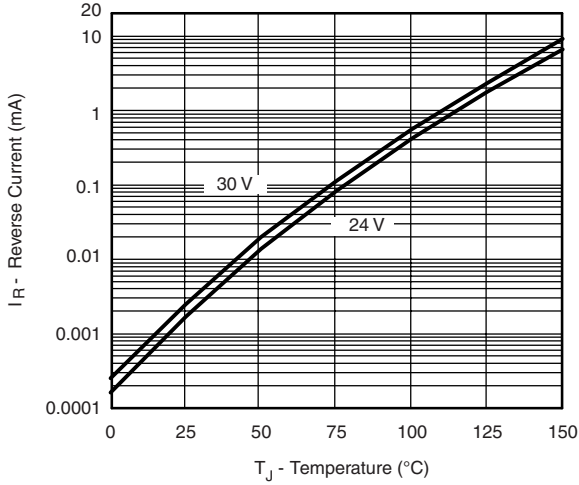


Normalized Thermal Transient Impedance, Junction-to-Foot

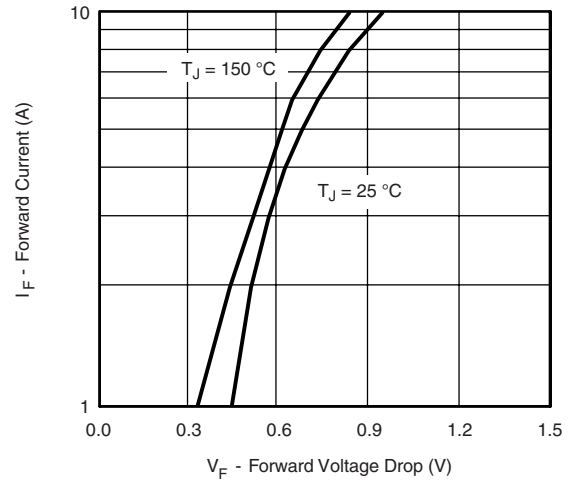
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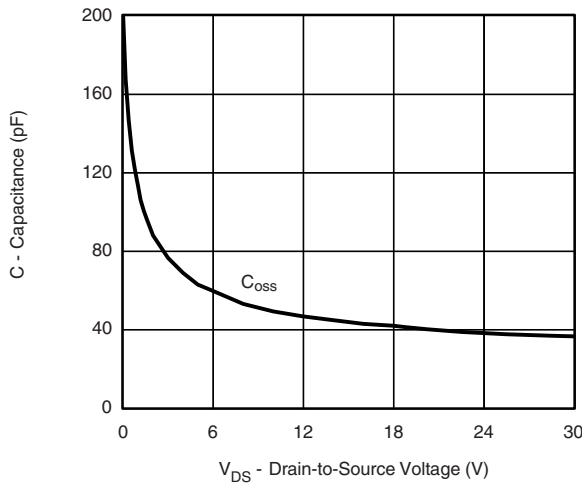
SCHOTTKY TYPICAL CHARACTERISTICS 25 °C unless otherwise noted



Reverse Current vs. Junction Temperature



Forward Voltage Drop



Capacitance

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